

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	243289	spacer	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:45
L2	18024	flip adj chip	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:45
L3	4696	thermocompression	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:26
L4	56762	waveguide	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:26
L5	12133	optical adj coupling	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:46
L6	143	1 and 2 and 3	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:27
L7	1	5 and 6	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:27
L8	21	lu-daoqiang.in.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:27
L9	12	8 and 2	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:28
L10	127	6 and @ad<"20030714"	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:45
L11	36193	(conductive solder) same (bump ball)	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:39
L12	574	11 and 5	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:39
L13	495	12 and @ad<"20030714"	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:39
L14	233	13 and 2	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:39
L15	74	14 and ("438"/\$3 "257"/\$3).ccls.	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:44

L16	1675	(438/64,108).CCLS.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/07/19 14:45
L17	74	15 and @ad<"20030714"	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:45
L18	1452	16 and @ad<"20030714"	US-PGPUB; USPAT; IBM_TDB	OR	ON	2005/07/19 14:45
L19	141796	spacer	EPO; JPO; DERWENT	OR	ON	2005/07/19 14:45
L20	9454	flip adj chip	EPO; JPO; DERWENT	OR	ON	2005/07/19 14:46
L21	6993	optical adj coupling	EPO; JPO; DERWENT	OR	ON	2005/07/19 14:46
L22	1	19 and 20 and 21	EPO; JPO; DERWENT	OR	ON	2005/07/19 14:46
L23	0	("2005/0013557").URPN.	USPAT	OR	ON	2005/07/19 14:46